



AC ЭНЕРГИЯ

# Thyristor T443-400-42



Mean on-state current		$I_{TAV}$	400 A	
Repetitive peak off-state voltage		$V_{DRM}$	3800 - 4200 V	
Repetitive peak reverse voltage		$V_{RRM}$		
Turn-off time		$t_q$	500, 630, 800 $\mu$ s	
$V_{DRM}, V_{RRM}, V$	3800	4000	4200	
Voltage code	38	40	42	
$T_j, ^\circ C$		-60 ÷ 125		

## MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
<b>ON-STATE</b>					
$I_{TAV}$	Mean on-state current	A	400 455	$T_c=92^\circ C$ , Double side cooled $T_c=85^\circ C$ , Double side cooled 180° half-sine wave; 50 Hz	
$I_{TRMS}$	RMS on-state current	A	628	$T_c=92^\circ C$ , Double side cooled 180° half-sine wave; 50 Hz	
$I_{TSM}$	Surge on-state current	kA	6.5 7.5	$T_j=T_{j\max}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=10$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ ms; $di_G/dt \geq 1$ A/ms
			7.0 8.0	$T_j=T_{j\max}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=8.3$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ ms; $di_G/dt \geq 1$ A/ms
$I^2t$	Safety factor	$A^2 s \cdot 10^3$	210 280	$T_j=T_{j\max}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=10$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ ms; $di_G/dt \geq 1$ A/ms
			200 260	$T_j=T_{j\max}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=8.3$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ ms; $di_G/dt \geq 1$ A/ms
<b>BLOCKING</b>					
$V_{DRM}, V_{RRM}$	Repetitive peak off-state and Repetitive peak reverse voltages	V	3800 - 4200	$T_{j\min} < T_j < T_{j\max}$ 180° half-sine wave; 50 Hz; Gate open	
$V_{DSM}, V_{RSM}$	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	3900 - 4300	$T_{j\min} < T_j < T_{j\max}$ 180° half-sine wave; single pulse; Gate open	
$V_D, V_R$	Direct off-state and Direct reverse voltages	V	$0.6V_{DRM}$ $0.6V_{RRM}$	$T_j=T_{j\max}$ Gate open	

<b>TRIGGERING</b>				
$I_{FGM}$	Peak forward gate current	A	8	$T_j=T_{j\max}$
$V_{RGM}$	Peak reverse gate voltage	V	5	
$P_G$	Gate power dissipation	W	4	
<b>SWITCHING</b>				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ( $f=1$ Hz)	A/ms	500	$T_j=T_{j\max}; V_D=0.67V_{DRM}; I_{TM}=1250$ A; Gate pulse: $I_G=2$ A; $t_{GP}=50$ ms; $di_G/dt \geq 2$ A/ms
<b>THERMAL</b>				
$T_{stg}$	Storage temperature	°C	-60...+50	
$T_j$	Operating junction temperature	°C	-60...+125	
<b>MECHANICAL</b>				
F	Mounting force	kN	14.0 - 16.0	
a	Acceleration	m/s <sup>2</sup>	50	Device clamped

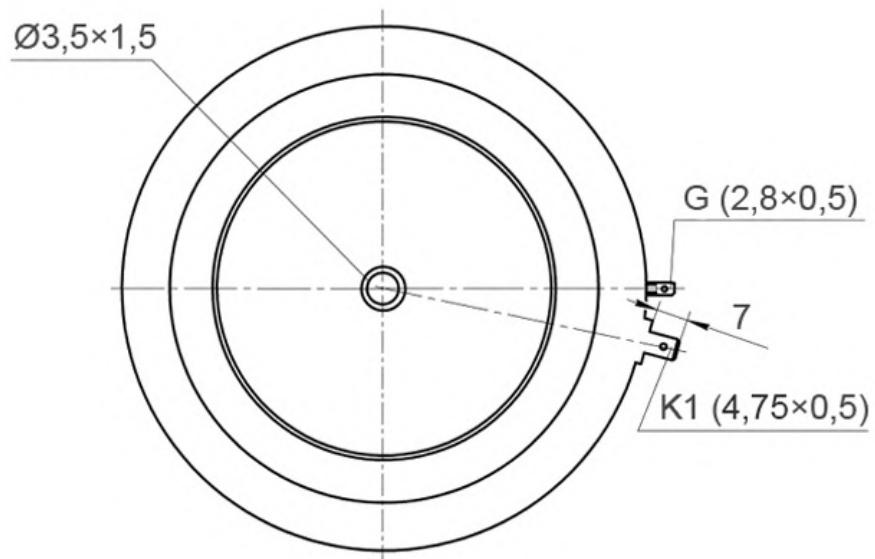
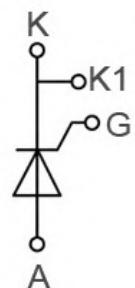
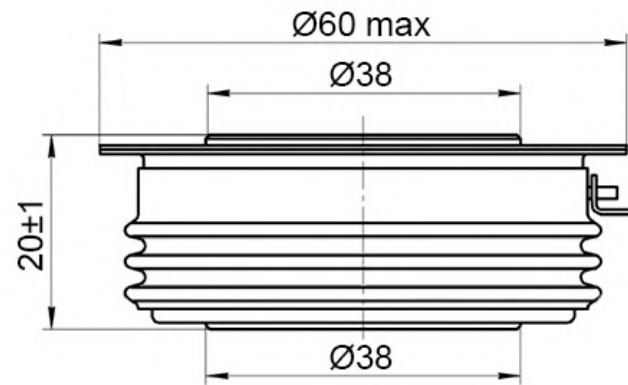
## CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions
<b>ON-STATE</b>				
$V_{TM}$	Peak on-state voltage, max	V	2.25	$T_j=25$ °C; $I_{TM}=1256$ A
$V_{T(TO)}$	On-state threshold voltage, max	V	1.117	$T_j=T_{j\max}$ ;
$r_T$	On-state slope resistance, max	mW	1.245	0.5 p $I_{TAV} < I_T < 1.5$ p $I_{TAV}$
$I_L$	Latching current, max	mA	1000	$T_j=25$ °C; $V_D=12$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ ms; $di_G/dt \geq 1$ A/ms
$I_H$	Holding current, max	mA	300	$T_j=25$ °C; $V_D=12$ V; Gate open
<b>BLOCKING</b>				
$I_{DRM}, I_{RRM}$	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	100	$T_j=T_{j\max}$ ; $V_D=V_{DRM}$ ; $V_R=V_{RRM}$
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/ms	200, 320, 500, 1000, 1600, 2000, 2500	$T_j=T_{j\max}$ ; $V_D=0.67V_{DRM}$ ; Gate open
<b>TRIGGERING</b>				
$V_{GT}$	Gate trigger direct voltage, max	V	3.00 2.50 1.50	$T_j=T_{j\min}$ $T_j=25$ °C $T_j=T_{j\max}$
$I_{GT}$	Gate trigger direct current, max	mA	400 250 150	$T_j=T_{j\min}$ $T_j=25$ °C $T_j=T_{j\max}$
$V_{GD}$	Gate non-trigger direct voltage, min	V	0.45	$T_j=T_{j\max}$ ;
$I_{GD}$	Gate non-trigger direct current, min	mA	55.00	$V_D=0.67V_{DRM}$ ; Direct gate current
<b>SWITCHING</b>				
$t_{gd}$	Delay time, max	ms	3.20	$T_j=25$ °C; $V_D=1500$ V; $I_{TM}=I_{TAV}$ ; $di/dt=200$ A/ms; Gate pulse: $I_G=2$ A; $V_G=20$ V; $t_{GP}=50$ ms; $di_G/dt=2$ A/ms
$t_{gt}$	Turn-on time, max	ms	15.00	
$t_q$	Turn-off time <sup>2)</sup> , max	ms	500, 630, 800	$dv_D/dt=50$ V/ms; $T_j=T_{j\max}$ ; $I_{TM}=I_{TAV}$ ; $di_R/dt=-5$ A/ms; $V_R=100$ V; $V_D=0.67V_{DRM}$
$Q_{rr}$	Total recovered charge, max	mC	1760	$T_j=T_{j\max}$ ; $I_{TM}=400$ A; $di_R/dt=-5$ A/ms; $V_R=100$ V
$t_{rr}$	Reverse recovery time, max	ms	40	
$I_{rrM}$	Peak reverse recovery current, max	A	88	

THERMAL					
$R_{thjc}$	Thermal resistance, junction to case, max	$^{\circ}\text{C}/\text{W}$	0.0350	Direct current	Double side cooled
$R_{thjc-A}$			0.0770		Anode side cooled
$R_{thjc-K}$			0.0630		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max	$^{\circ}\text{C}/\text{W}$	0.0060	Direct current	
MECHANICAL					
w	Weight, max	g	240		
$D_s$	Surface creepage distance	mm (inch)	19.44 (0.765)		
$D_a$	Air strike distance	mm (inch)	12.10 (0.476)		

### OVERALL DIMENSIONS

Package type: T.C2, (PT42)



K – cathode;

All dimensions in millimeters

A – anode;

K1 – auxiliary cathode;

G – gate;

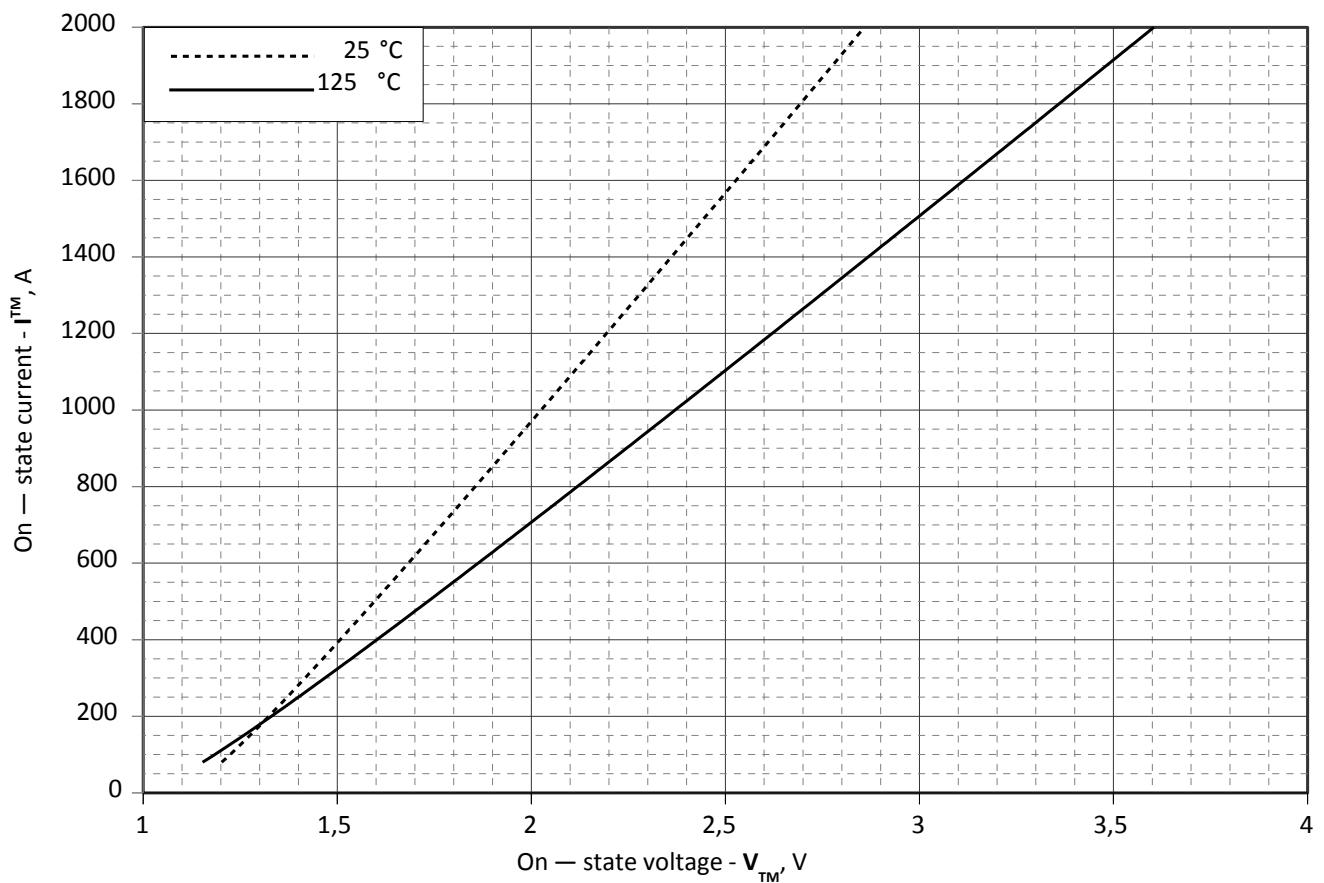


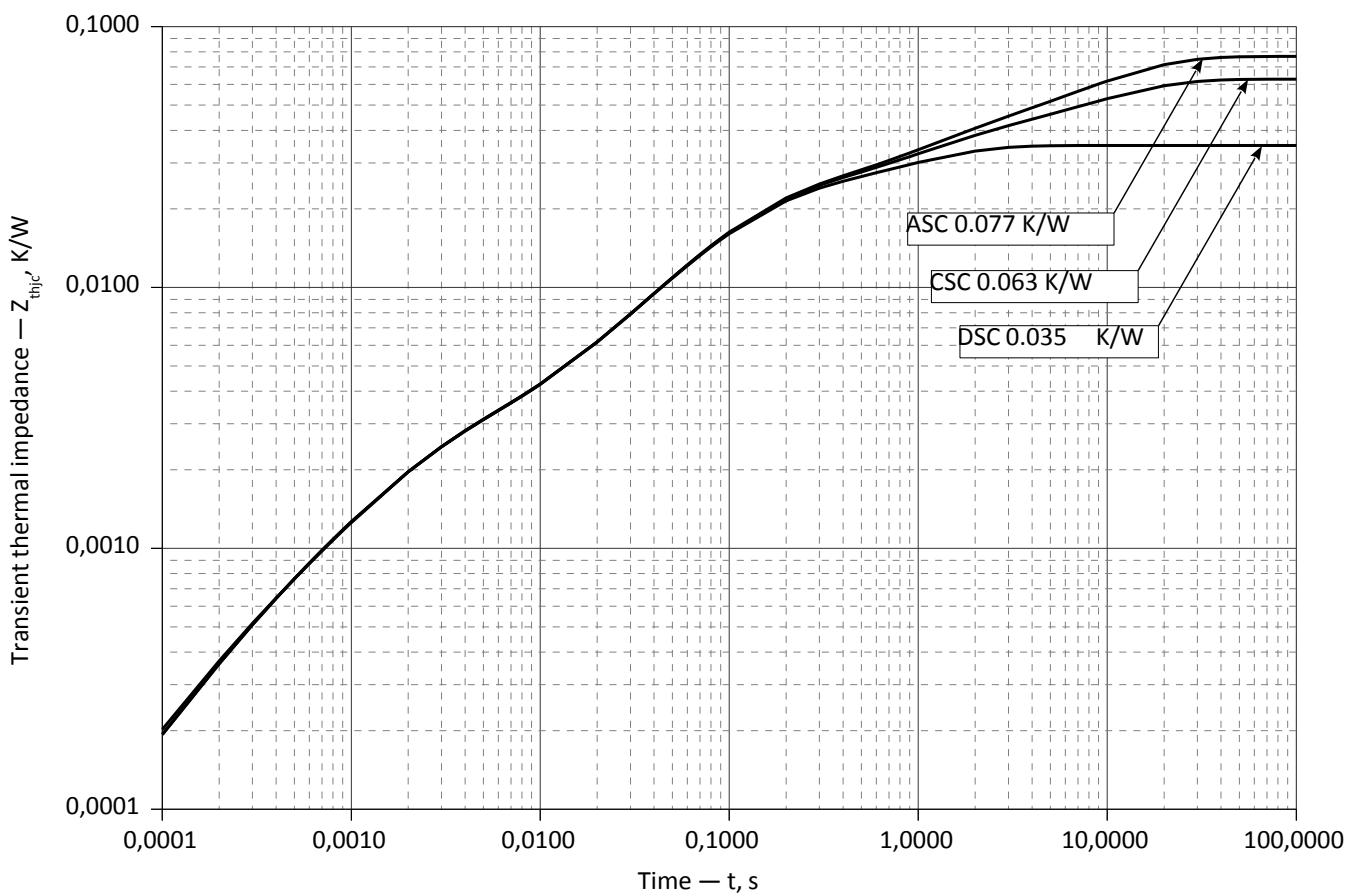
Fig 1 – On-state characteristics of Limit device

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j,\max}$
<b>A</b>	1.05900000	0.97757680
<b>B</b>	0.00078162	0.00114000
<b>C</b>	0.01165600	0.00518530
<b>D</b>	0.00329660	0.00687000

On-state characteristic model (see Fig. 1)



**Fig 2 – Transient thermal impedance  $Z_{thjc}$  vs. time  $t$**

Analytical function for Transient thermal impedance junction to case  $Z_{thjc}$  for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left( 1 - e^{-\frac{t}{\tau_i}} \right)$$

Where  $i = 1$  to  $n$ ,  $n$  is the number of terms in the series.

$t$  = Duration of heating pulse in seconds.  $Z_{thjc}$

= Thermal resistance at time  $t$ .

$R_i$  = Amplitude of  $r_{th}$  term.

$\tau_i$  = Time constant of  $r_{th}$  term.

DC Double side cooled

i	1	2	3	4	5	6
$R_i$ , K/W	2.007e-005	0.01412	0.01797	0.0007764	0.00193	0.0001844
$\tau_i$ , s	4.957	0.9362	0.09335	0.04227	0.001702	0.0002492

DC Anode side cooled

i	1	2	3	4	5	6
$R_i$ , K/W	0.04173	0.01173	0.01847	0.001981	0.0001722	0.002719
$\tau_i$ , s	9.751	1.085	0.09044	0.00175	0.0001916	0.791

DC Cathode side cooled

i	1	2	3	4	5	6
$R_i$ , K/W	0.02781	0.0007698	0.01797	0.001931	0.000209	0.01416
$\tau_i$ , s	9.752	0.186	0.08881	0.001757	0.0002747	1.004

**Transient thermal impedance junction to case  $Z_{thjc}$  model (see Fig. 2)**

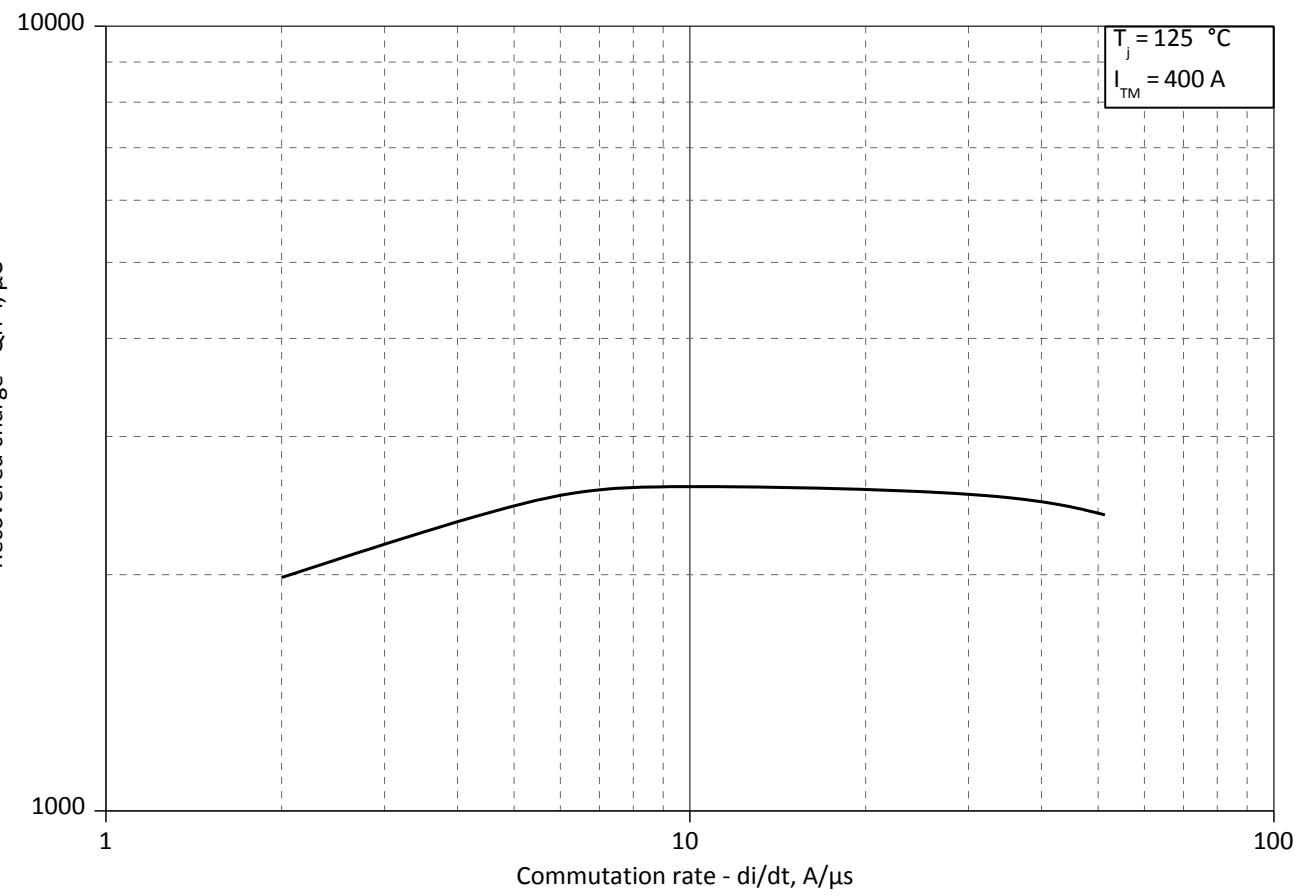


Fig 3 – Maximum recovered charge  $Q_{rr-i}$  (integral) vs. commutation rate  $di_r/dt$

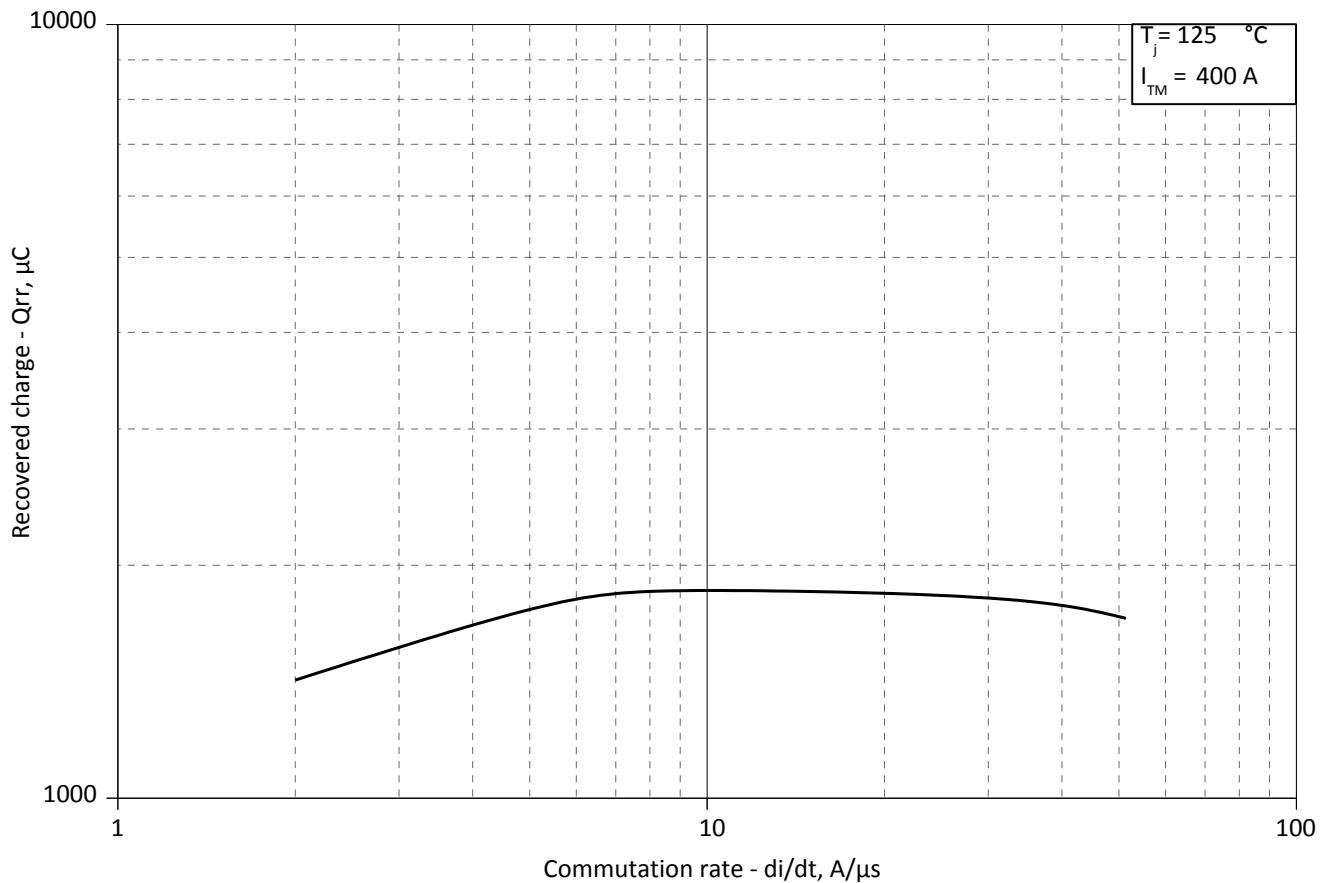
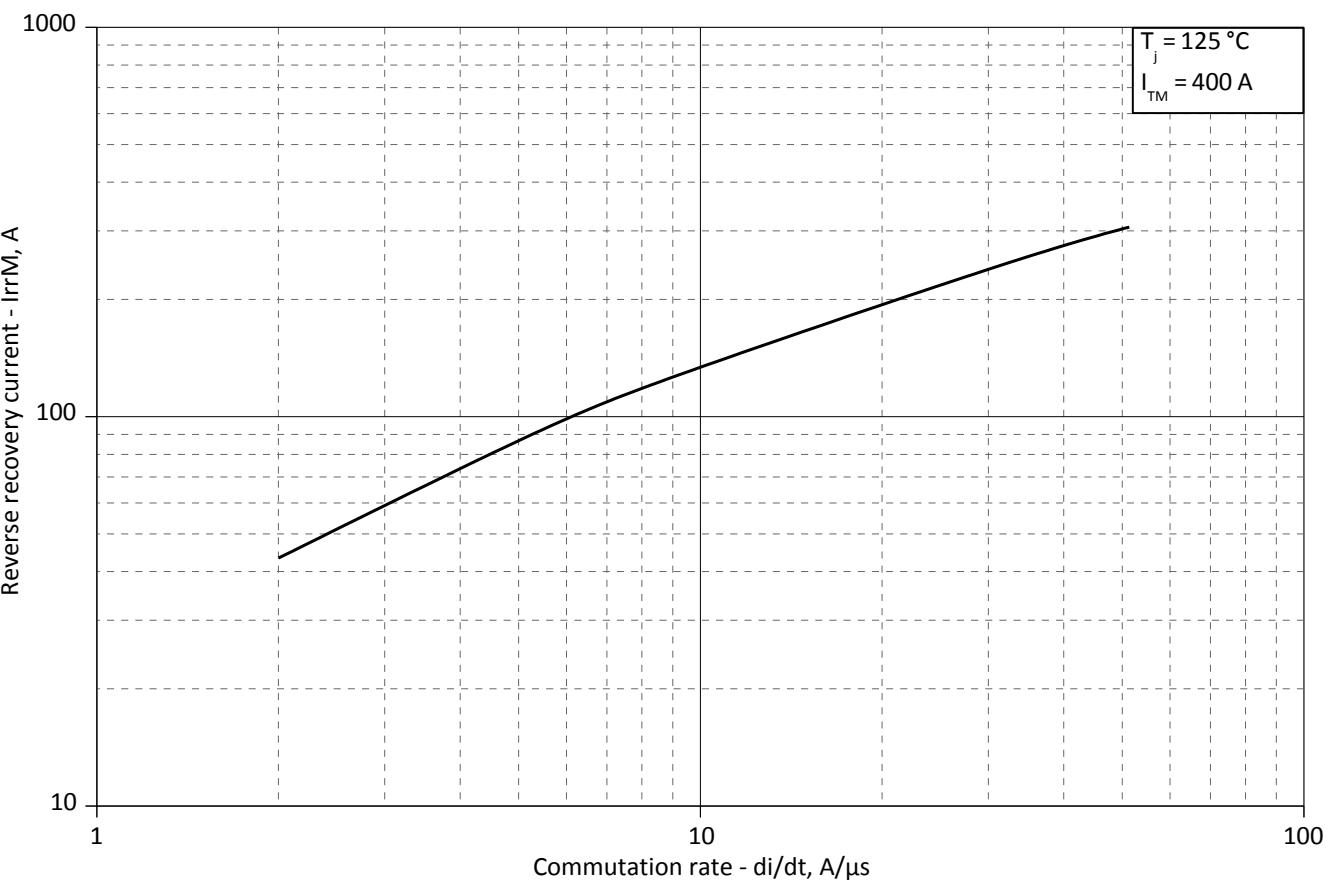
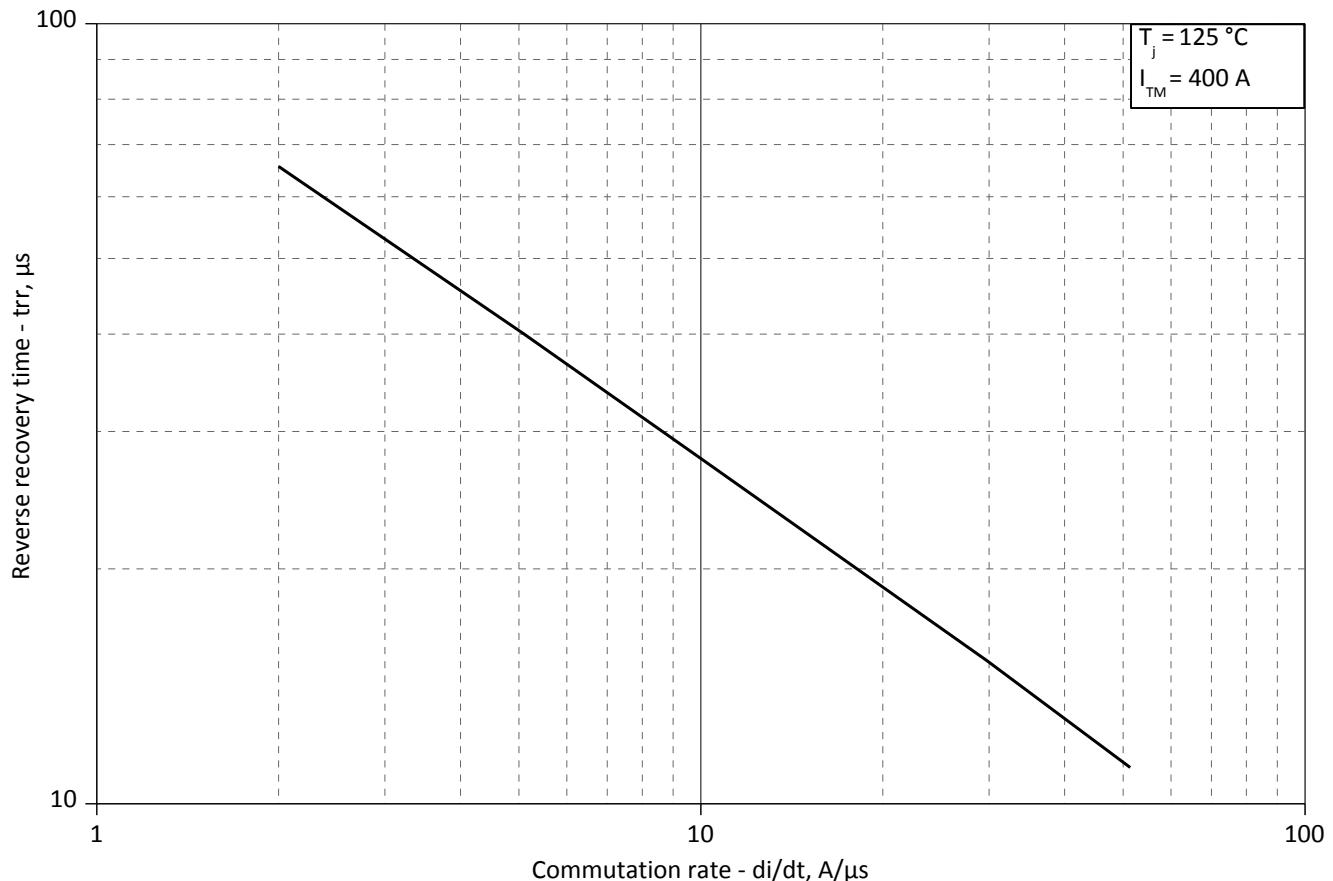


Fig 4 – Maximum recovered charge  $Q_{rr}$  vs. commutation rate  $di_r/dt$  (25% chord)



**Fig 5 – Maximum reverse recovery current  $I_{rrM}$  vs. commutation rate  $di_R/dt$**



**Fig 6 – Maximum recovery time  $t_{rr}$  vs. commutation rate  $di_R/dt$  (25% chord)**

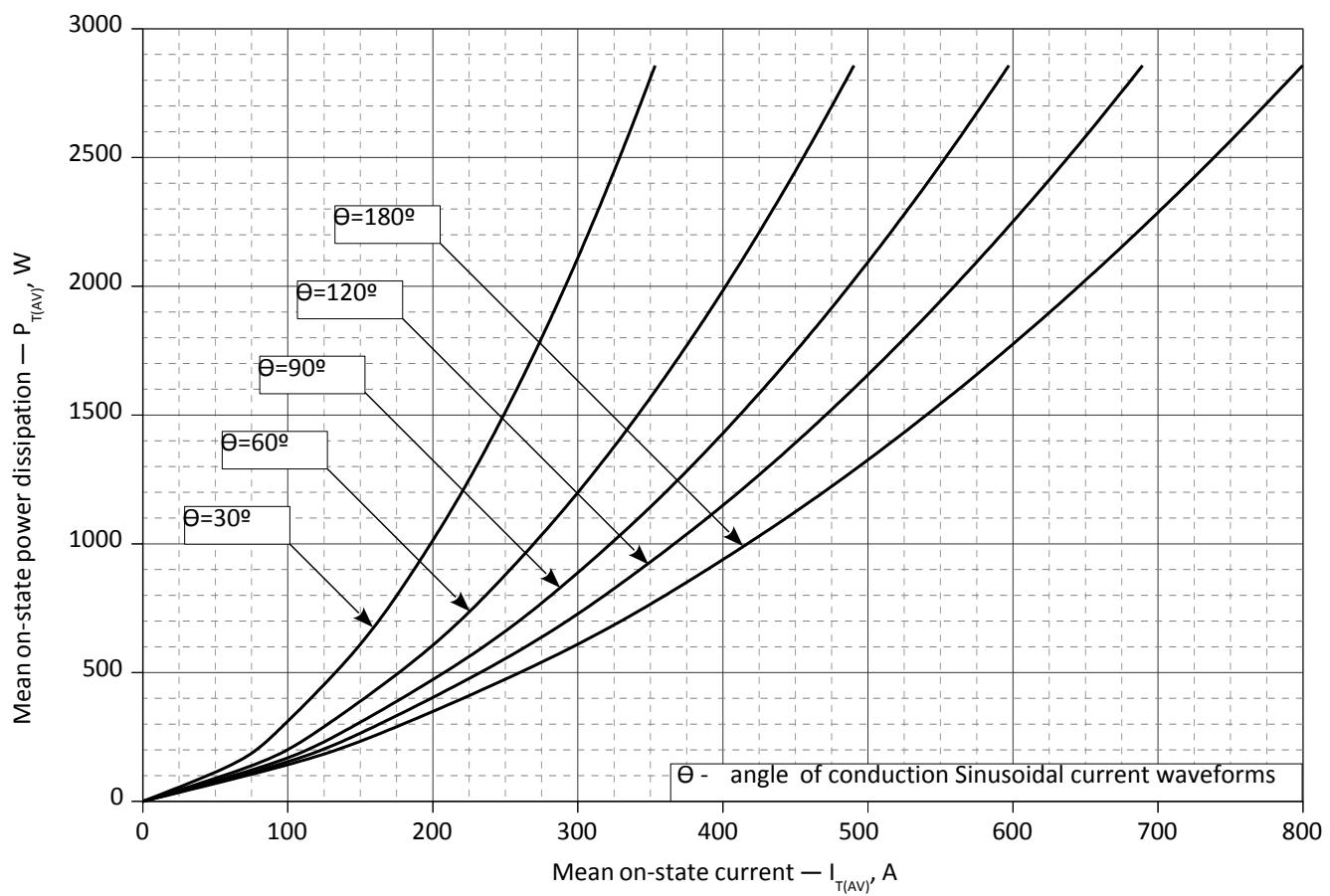


Fig. 7 - Mean on-state power dissipation  $P_{TAV}$  vs. mean on-state current  $I_{TAV}$  for sinusoidal current waveforms at different conduction angles (f=50Hz, DSC)

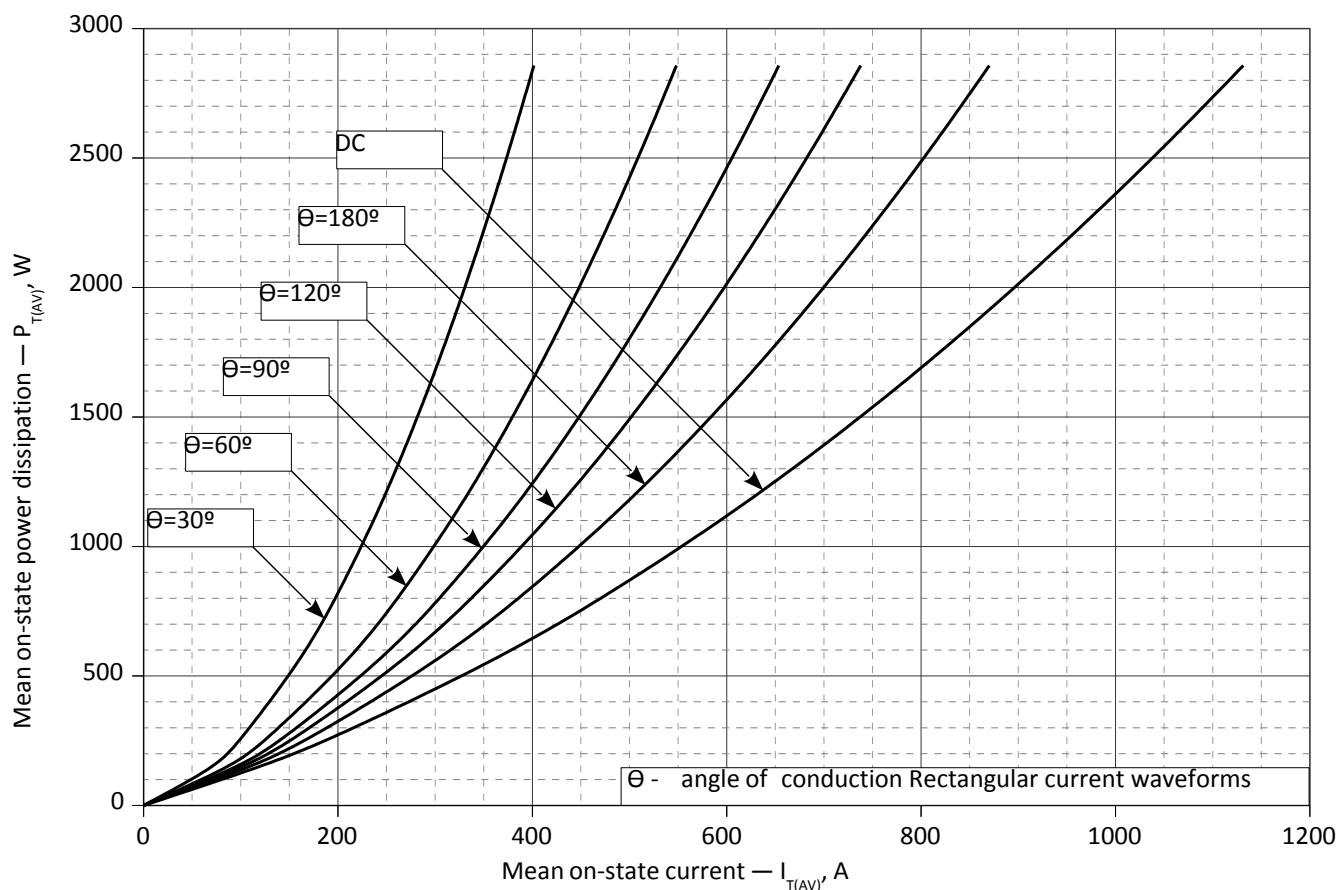


Fig. 8 – Mean on-state power dissipation  $P_{TAV}$  vs. mean on-state current  $I_{TAV}$  for rectangular current waveforms at different conduction angles and for DC (f=50Hz, DSC)

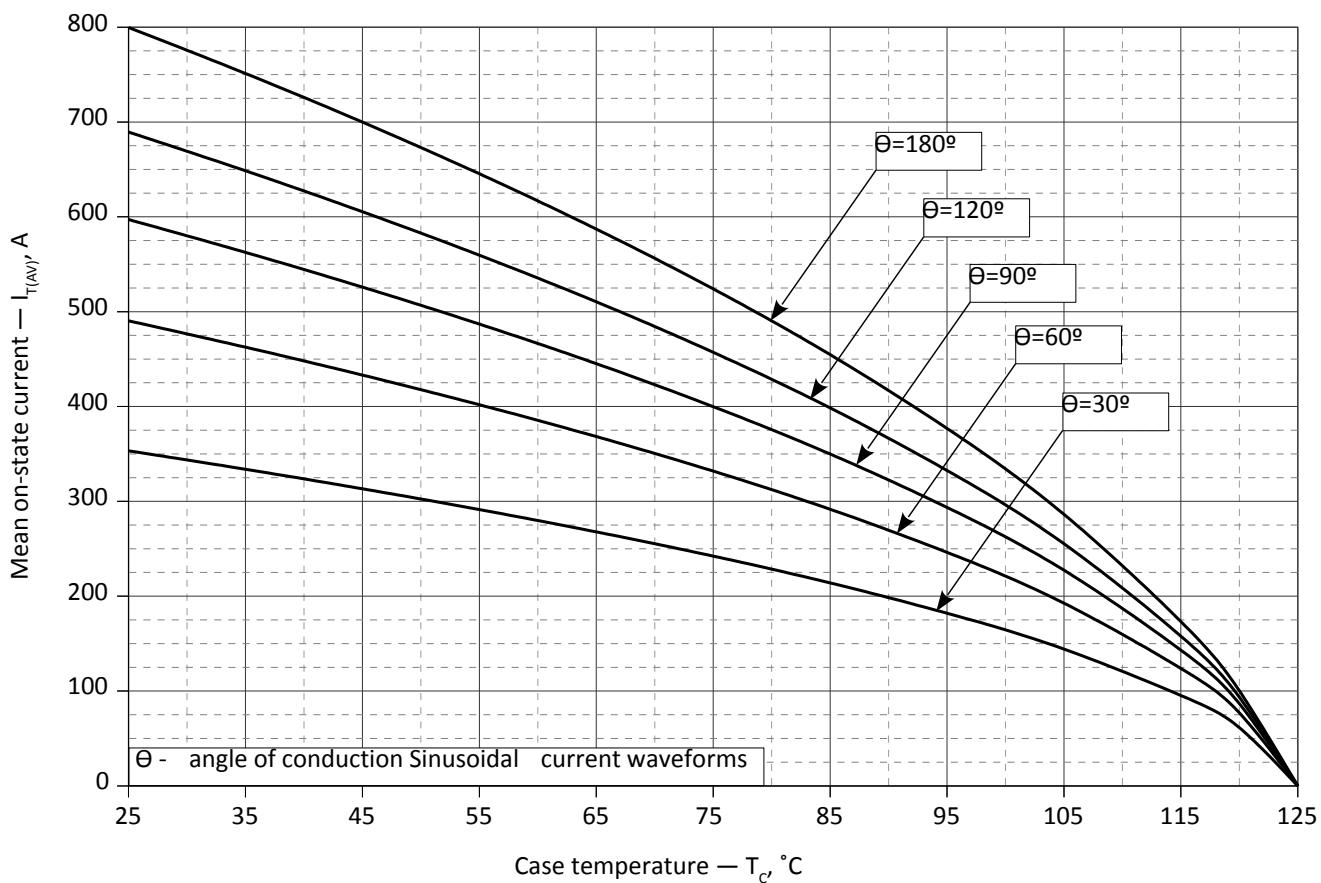


Fig. 9 – Mean on-state current  $I_{TAV}$  vs. case temperature  $T_c$  for sinusoidal current waveforms at different conduction angles (f=50Hz, DSC)

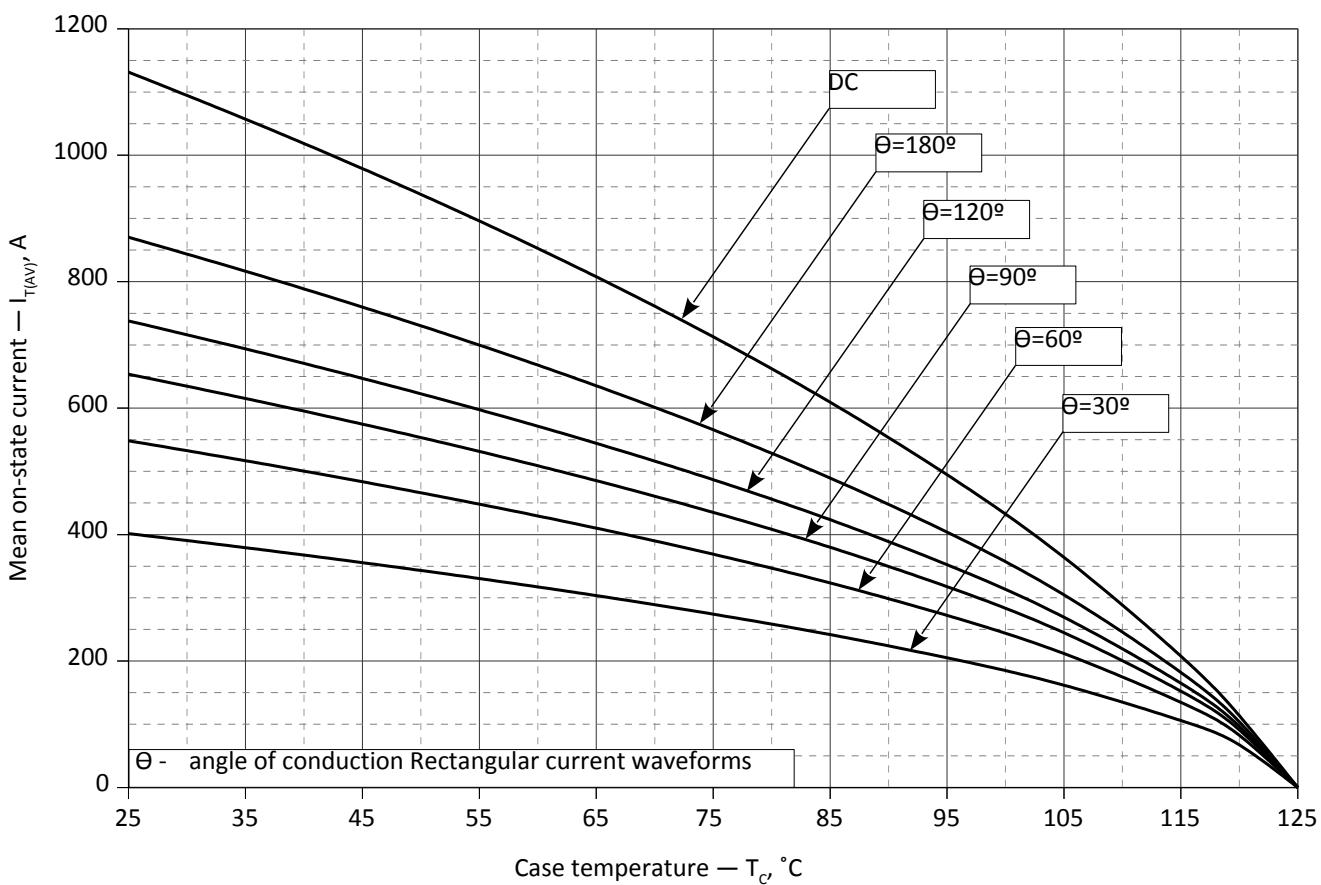


Fig. 10 - Mean on-state current  $I_{TAV}$  vs. case temperature  $T_c$  for rectangular current waveforms at different conduction angles and for DC (f=50Hz, DSC)

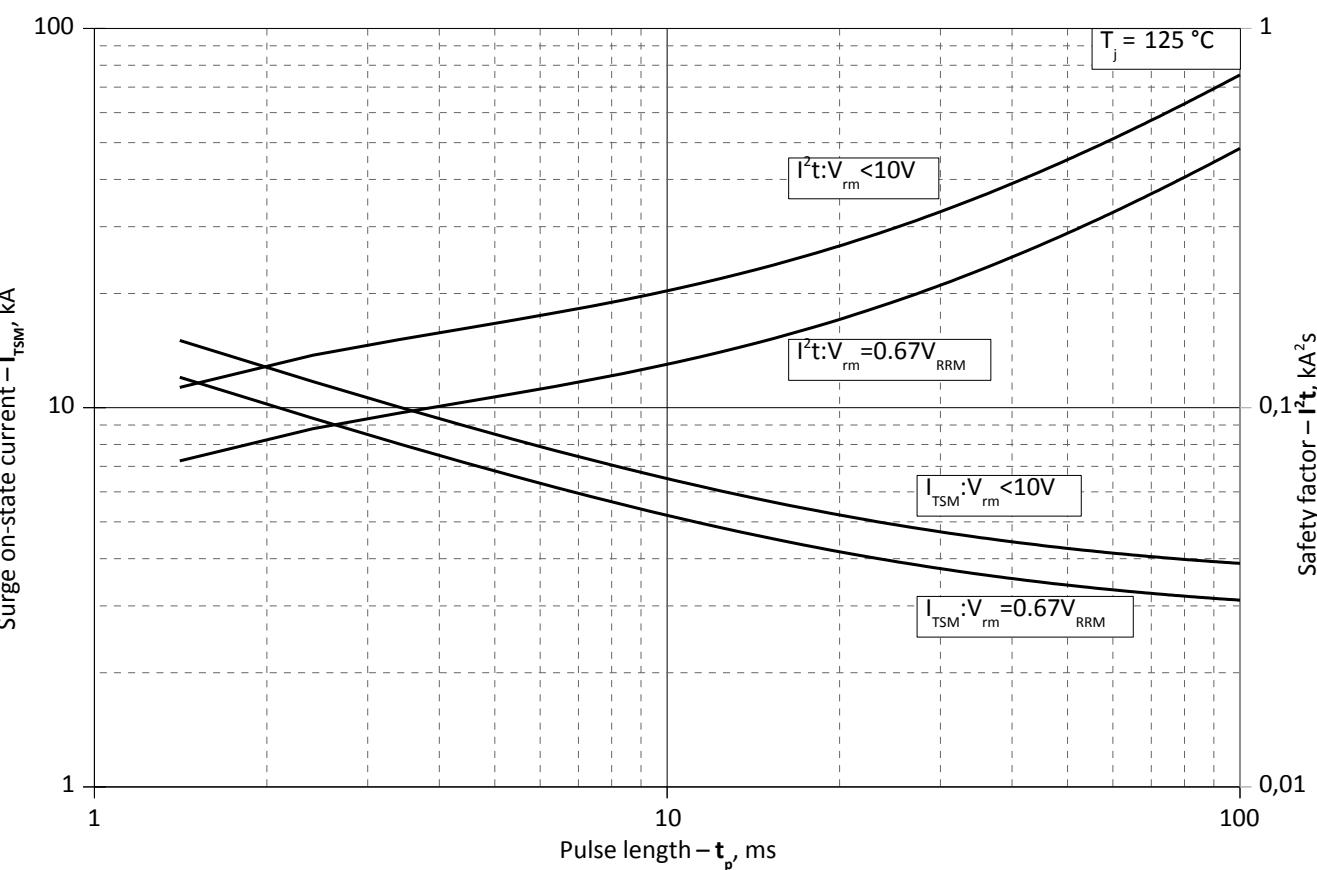


Fig. 11 – Maximum surge on-state current  $I_{TSM}$  and safety factor  $I^2t$  vs. pulse length  $t_p$

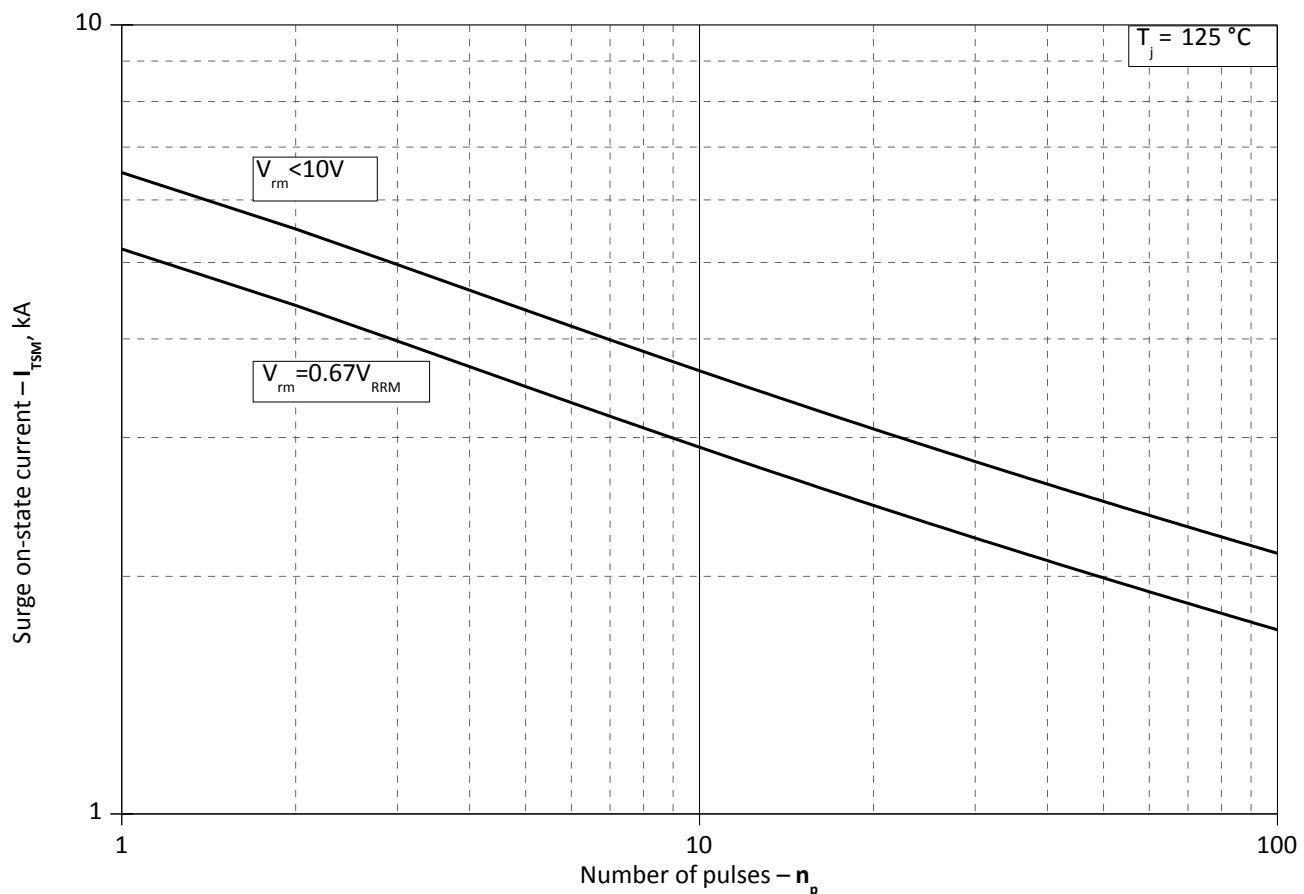


Fig. 12 - Maximum surge on-state current  $I_{TSM}$  vs. number of pulses  $n_p$